

# MYLAN PS-PLATE DEVELOPER GSP500

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## TECHNICAL SPECIFICATIONS

Description	Minimum aggression of the coating in the non-imaged areas obtaining the maximum cleaning of the imaged areas. Maintaining in the bath the correct conductivity values. High emulsion dissolving properties to minimize the accumulation of residuals in the automatic processor. Long life in processor. Highly recommended for <b>CTcP plate, PS-Plate</b> .
Application	Development in processors for thermal plates. Machine use dilute 1 + 5 with water
Specifications	pH value above 13 and Conductivity between 68 to 72 mS at 25°C
Working temperature	25°C ± 1°C
Developer time	30 ± 5 seconds in immersion
Replenishment	Use MyLan PS-Plate developer GSP500 dilute 1 + 2 with water
Replenishment rate	80 ÷ 120 ml/m <sup>2</sup>
Considerations	Adequate replenishment keeps filters and circulation systems clean prolonging the life of the bath. Correct cleaning of the equipment will avoid contamination of the new bath and prolong the life of the processor.
Safelight	None required - daylight handling
Shelf life	12 months under recommended storage conditions
Packaging	10, 20 liters
Transport and storage	Should be stored flat and away from excessive cold, heat and humidity. Use in a controlled environment of 5°C – 30°C and 40 – 80% RH, non-condensing
Availability	Contact your local MyLan Group representative. See the list of our Distributors at <a href="http://www.mylangroup.com">www.mylangroup.com</a> for contact information.

### MYLAN GROUP